## **Declaration, Power of Attorney and Petition**

WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

HDAC INHIBITOR					
the specification of which	•			,	
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🔀 is attached h	ereto.	•			·. ·
was filed on		as		2	
Application	Serial No.				
and amended	i on		•		
was filed as	PCT international application	n			
Number		·			
on		·,		,	
and was ame	ended under PCT Article 19	; •			
on	(if app	licable).		٠	
including the claims, as amende	priority benefits under 35 Ucate, or §365(a) of any PC States, listed below and haver's certificate, or PCT Inter	ed to above.  Inown to be material to the lations.  J.S.C. §119(a)-(d) or §365  I International application e also identified below, be mational application having	e patentability	y of this apportion applications applicated at lessented to the box, any	ation(s) ast one foreign
Application No.	Country	Day/Month/Yea	r	Priority Claimed	
2003900116	Australia	13/1/2003		⊠ Yes [	No
2003905406	Australia	6/10/2003	. [	Yes □	No
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application(s) listed below.	- 110 JJ, Omiod J	tates Code, §119(e) of any United States provision
(Application Number)	_	(Filing Date)
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PCT International application designating the claims of this application is not disclosed provided by the first paragraph of 35 U.S.C.	ne United States, list d in the prior United §112, I acknowledg hich became availab	United States application(s), or under §365(c) of an ed below and, insofar as the subject matter of each of States or PCT International application in the manner the duty to disclose information which is material to be between the filing date of the prior application and
Application Serial No.	Filing Date	Status (pending, patented, abandoned)
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And we (I) hereby appoint the following	ng registered practition	oner(s):
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as our (my) attorneys, with full powers of subusiness in the Patent Office connected the application be sent to	bstitution and revoc	ation, to prosecute this application and to transact all ereby request that all correspondence regarding this
	22850	
on information and belief are believed to be t willful false statements and the like so made	herein of our (my) or rue; and further that are punishable by f	wn knowledge are true and that all statements made these statements were made with the knowledge that ine or imprisonment, or both, under Section 1001 of ements may jeopardize the validity of the application
Yasuharu URANO	R	esidence: Osaka-shi, Osaka, Japan
NAME OF FIRST OR SOLE INVENTOR		
91.10 91		******
Signature of Inventor	C	itizen of: Japan
Signature of hivernor	. M	ailing Address: c/o Fujisawa Pharmaceutical Co.,
•	L	d., 4-7, Doshomachi 3-chome, Chuo-ku, Osaka-shi,
January 7, 2004		saka 541-8514 Japan
Date .		

Shigeki SATOH	Residence: Osaka-shi, Osaka, Japan
NAME OF SECOND JOINT INVENTOR	
Shipli Satoh	
Smith Janes	Citizen of: Japan
Signature of Inventor	Mailing Address: c/o Fujisawa Pharmaceutical Co.,
	Ltd., 4-7, Doshomachi 3-chome, Chuo-ku, Osaka-shi,
January 7, 2004	Osaka 541-8514 Japan
Date	
Naoki ISHIBASHI	Residence: Osaka-shi, Osaka, Japan
NAME OF THIRD JOINT INVENTOR	
naoki Ishibashi	Citizen of: Japan
Signature of Inventor	Mailing Address: c/o Fujisawa Pharmaceutical Co.,
	Ltd., 4-7, Doshomachi 3-chome, Chuo-ku, Osaka-shi,
January 7, 2004	
Date	Osaka 541-8514 Japan
	· -
Kazunori KAMIJO	Residence: Osaka-shi, Osaka, Japan
NAME OF FOURTH JOINT INVENTOR	Nesidence. Osaka-sin, Osaka, Japan
V	
Signature of Inventor	Citizen of:
Signature of inventor	Mailing Address: c/o Fujisawa Pharmaceutical Co.,
	Ltd., 4-7, Doshomachi 3-chome, Chuo-ku, Osaka-shi,
January 7, 2004	Osaka 541-8514 Japan
Date	
NAME OF EIGHT LODIT DIVENTOR	Residence:
NAME OF FIFTH JOINT INVENTOR	
	Citizen of:
Signature of Inventor	Mailing Address:
	·
Date	-